


**HARRIS**  
SEMICONDUCTOR

# CA3045, CA3046

## General Purpose N-P-N Transistor Arrays

March 1993

### Features

- Two Matched Transistors:  $V_{BE}$  Matched  $\pm 5mV$ ; Input Offset Current  $2\mu A$  Max at  $I_C = 1mA$
- 5 General Purpose Monolithic Transistors
- Operation From DC to 120MHz
- Wide Operating Current Range
- Low Noise Figure 3.2dB Typical at 1kHz
- Full Military Temperature Range  $-55^\circ C$  to  $+125^\circ C$

### Applications

- Three Isolated Transistors and One Differentially Connected Transistor Pair for Low Power Applications at Frequencies from DC Through the VHF Range
- Custom Designed Differential Amplifiers
- Temperature Compensated Amplifiers
- See Application Note, AN5296 "Application of the CA3018 Integrated-Circuit Transistor Array" for Suggested Applications

### Description

The CA3045 and CA3046 each consist of five general purpose silicon n-p-n transistors on a common monolithic substrate. Two of the transistors are internally connected to form a differentially connected pair.

The transistors of the CA3045 and CA3046 are well suited to a wide variety of applications in low power systems in the DC through VHF range. They may be used as discrete transistors in conventional circuits. However, in addition, they provide the very significant inherent integrated circuit advantages of close electrical and thermal matching.

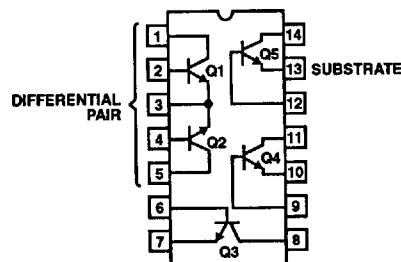
### Ordering Information

PART NUMBER	TEMPERATURE RANGE	PACKAGE
CA3045	$-55^\circ C$ to $+125^\circ C$	14 Lead Ceramic Sidebrazed DIP
CA3045F	$-55^\circ C$ to $+125^\circ C$	14 Lead Ceramic DIP
CA3046	$-55^\circ C$ to $+125^\circ C$	14 Lead Plastic DIP
CA3046M	$-55^\circ C$ to $+125^\circ C$	14 Lead SOIC
CA3046M96	$-55^\circ C$ to $+125^\circ C$	14 Lead SOIC*

\* Denotes Tape and Reel

### Pinout

CA3045, CA3046  
(PDIP, CDIP, SOIC)  
TOP VIEW



Specifications CA3045, CA3046

**Absolute Maximum Ratings** (T<sub>A</sub> = +25°C)

Collector-to-Emitter Voltage (V <sub>CEO</sub> )	15V
Collector-to-Base Voltage (V <sub>CBO</sub> )	20V
Collector-to-Substrate Voltage (V <sub>CJO</sub> ) (Note 1)	20V
Emitter-to-Base Voltage (V <sub>EBO</sub> )	5V
Collector Current (I <sub>C</sub> )	50mA
Power Dissipation	

CA3045	Each Transistor	Total Pkg.
Up to T <sub>A</sub> = +75°C	300mW	750mW
Above T <sub>A</sub> = +75°C	Derate Linearly 8mW/°C	
CA3046, CA3045F	Each Transistor	Total Pkg.
Up to T <sub>A</sub> = +55°C	300mW	750mW
Above T <sub>A</sub> = +55°C	Derate Linearly 6.67mW/°C	

Junction Temperature	+175°C
Junction Temperature (Plastic Package)	+150°C
Lead Temperature (Soldering 10 Sec.)	+300°C

**Operating Conditions**

Operating Temperature Range	-55°C ≤ T <sub>A</sub> ≤ +125°C
Storage Temperature Range	-65°C ≤ T <sub>A</sub> ≤ 150°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

**Electrical Specifications** T<sub>A</sub> = +25°C, Characteristics apply for each transistor in CA3045 & CA3046 as specified.

PARAMETERS	SYMBOL	TEST CONDITIONS	LIMITS			UNITS	
			MIN	TYP	MAX		
<b>STATIC CHARACTERISTICS</b>							
Collector-to-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> = 10μA, I <sub>E</sub> = 0	20	60	-	V	
Collector-to-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> = 1mA, I <sub>B</sub> = 0	15	24	-	V	
Collector-to-Substrate Breakdown Voltage	V <sub>(BR)CJO</sub>	I <sub>C</sub> = 10μA, I <sub>C1</sub> = 0	20	60	-	V	
Emitter-to-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> = 10μA, I <sub>C</sub> = 0	5	7	-	V	
Collector Cutoff Current (Figure 1)	I <sub>CBO</sub>	V <sub>CB</sub> = 10V, I <sub>E</sub> = 0	-	0.002	40	nA	
Collector Cutoff Current (Figure 2)	I <sub>CEO</sub>	V <sub>CE</sub> = 10V, I <sub>B</sub> = 0	-	See Fig. 2	0.5	μA	
Static Forward Current Transfer Ratio (Static Beta) (Note 2) (Figure 3)	h <sub>FE</sub>	V <sub>CE</sub> = 3V	I <sub>C</sub> = 10mA	-	100	-	-
			I <sub>C</sub> = 1mA	40	100	-	-
			I <sub>C</sub> = 10μA	-	54	-	-
Input Offset Current for Matched Pair Q <sub>1</sub> and Q <sub>2</sub> .  I <sub>O1</sub> - I <sub>O2</sub>   (Note 2) (Figure 4)		V <sub>CE</sub> = 3V, I <sub>C</sub> = 1mA	-	0.3	2	μA	
Base-to-Emitter Voltage (Note 2) (Figure 5)	V <sub>BE</sub>	V <sub>CE</sub> = 3V	I <sub>E</sub> = 1mA	-	0.715	-	V
			I <sub>E</sub> = 10mA	-	0.800	-	V
Magnitude of Input Offset Voltage for Differential Pair  V <sub>BE1</sub> - V <sub>BE2</sub>   (Note 2) (Figures 5, 7)		V <sub>CE</sub> = 3V, I <sub>C</sub> = 1mA	-	0.45	5	mV	
Magnitude of Input Offset Voltage for Isolated Transistors  V <sub>BE3</sub> - V <sub>BE4</sub>  ,  V <sub>BE4</sub> - V <sub>BE5</sub>  ,  V <sub>BE5</sub> - V <sub>BE3</sub>   (Note 2) (Figures 5, 7)		V <sub>CE</sub> = 3V, I <sub>C</sub> = 1mA	-	0.45	5	mV	
Temperature Coefficient of Base-to-Emitter Voltage (Figure 6)	$\frac{\Delta V_{BE}}{\Delta T}$	V <sub>CE</sub> = 3V, I <sub>C</sub> = 1mA	-	-1.9	-	mV/°C	
Collector-to-Emitter Saturation Voltage	V <sub>CES</sub>	I <sub>B</sub> = 1mA, I <sub>C</sub> = 10mA	-	0.23	-	V	
Temperature Coefficient: Magnitude of Input Offset Voltage (Figure 7)	$\frac{ \Delta V_{IO} }{\Delta T}$	V <sub>CE</sub> = 3V, I <sub>C</sub> = 1mA	-	1.1	-	μV/°C	

Specifications CA3045, CA3046

Electrical Specifications  $T_A = +25^\circ\text{C}$ , Characteristics apply for each transistor in CA3045 & CA3046 as specified. (Continued)

PARAMETERS	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
DYNAMIC CHARACTERISTICS						
Low Frequency Noise Figure (Figure 9)	NF	$f = 1\text{ kHz}, V_{CE} = 3\text{ V}, I_C = 100\mu\text{A}$ , Source Resistance = $1\text{ k}\Omega$	-	3.25	-	dB
Low Frequency, Small Signal Equivalent Circuit Characteristics						
Forward Current Transfer Ratio (Figure 11)	$h_{FE}$	$f = 1\text{ kHz}, V_{CE} = 3\text{ V}, I_C = 1\text{ mA}$	-	110	-	-
Short Circuit Input Impedance (Figure 11)	$h_{iE}$	$f = 1\text{ kHz}, V_{CE} = 3\text{ V}, I_C = 1\text{ mA}$	-	3.5	-	$\text{k}\Omega$
Open Circuit Output Impedance (Figure 11)	$h_{oE}$	$f = 1\text{ kHz}, V_{CE} = 3\text{ V}, I_C = 1\text{ mA}$	-	15.6	-	$\mu\text{mho}$
Open Circuit Reverse Voltage Transfer Ratio (Figure 11)	$h_{rE}$	$f = 1\text{ kHz}, V_{CE} = 3\text{ V}, I_C = 1\text{ mA}$	-	$1.8 \times 10^{-4}$	-	-
Admittance Characteristics						
Forward Transfer Admittance (Figure 12)	$Y_{FE}$	$f = 1\text{ kHz}, V_{CE} = 3\text{ V}, I_C = 1\text{ mA}$	-	$31 - j1.5$	-	-
Input Admittance (Figure 13)	$Y_{iE}$	$f = 1\text{ kHz}, V_{CE} = 3\text{ V}, I_C = 1\text{ mA}$	-	$0.3 + j0.04$	-	-
Output Admittance (Figure 14)	$Y_{oE}$	$f = 1\text{ kHz}, V_{CE} = 3\text{ V}, I_C = 1\text{ mA}$	-	$0.001 + j0.03$	-	-
Reverse Transfer Admittance (Figure 15)	$Y_{rE}$	$f = 1\text{ kHz}, V_{CE} = 3\text{ V}, I_C = 1\text{ mA}$	-	See Fig. 14	-	-
Gain Bandwidth Product (Figure 16)	$f_T$	$V_{CE} = 3\text{ V}, I_C = 3\text{ mA}$	300	550	-	MHz
Emitter-to-Base Capacitance	$C_{EB}$	$V_{EB} = 3\text{ V}, I_E = 0$	-	0.6	-	pF
Collector-to-Base Capacitance	$C_{CB}$	$V_{CB} = 3\text{ V}, I_C = 0$	-	0.58	-	pF
Collector-to-Substrate Capacitance	$C_{Cl}$	$V_{CS} = 3\text{ V}, I_C = 0$	-	2.8	-	pF

NOTE:

1. The collector of each transistor of the CA3045 and CA3046 is isolated from the substrate by an integral diode. The substrate (Terminal 13) must be connected to the most negative point in the external circuit to maintain isolation between transistors and to provide for normal transistor action.
2. Actual forcing current is via the emitter for this test.

Typical Performance Curves

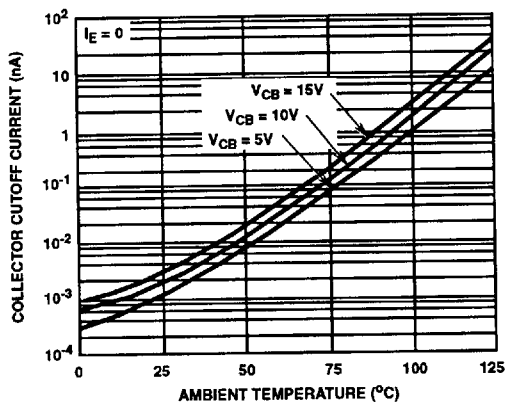


FIGURE 1. TYPICAL COLLECTOR-TO-BASE CUTOFF CURRENT vs TEMPERATURE FOR EACH TRANSISTOR

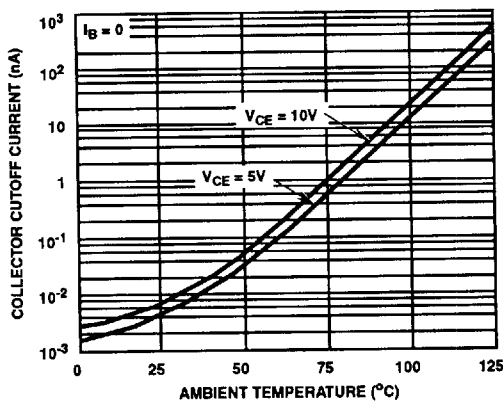


FIGURE 2. TYPICAL COLLECTOR-TO-EMITTER CUTOFF CURRENT vs TEMPERATURE FOR EACH TRANSISTOR

6  
TRANSISTOR AND  
DIODE ARRAYS

Typical Performance Curves (Continued)

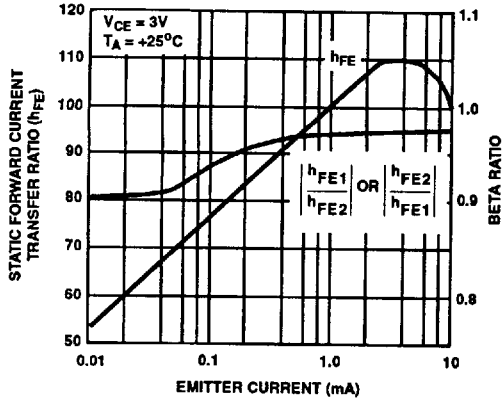


FIGURE 3. TYPICAL STATIC FORWARD CURRENT TRANSFER RATIO AND BETA RATIO FOR  $Q_1$  AND  $Q_2$  vs EMITTER CURRENT

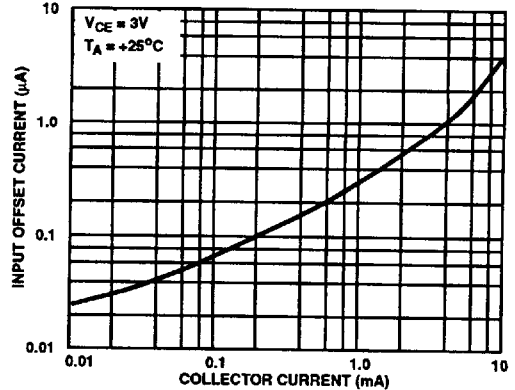


FIGURE 4. TYPICAL INPUT OFFSET CURRENT FOR MATCHED TRANSISTOR PAIR  $Q_1, Q_2$  vs COLLECTOR CURRENT

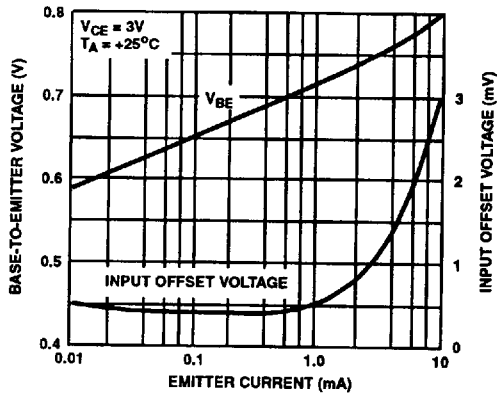


FIGURE 5. TYPICAL STATIC BASE-TO-EMITTER VOLTAGE CHARACTERISTICS AND INPUT OFFSET VOLTAGE FOR DIFFERENTIAL PAIR AND PAIRED ISOLATED TRANSISTORS vs EMITTER CURRENT

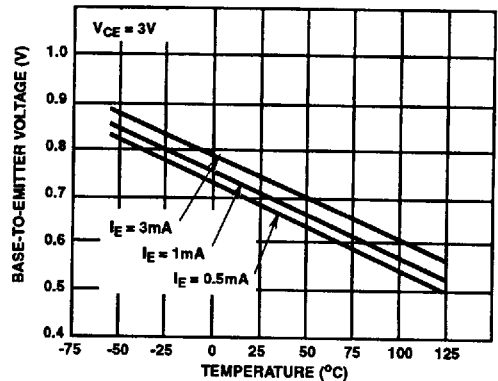


FIGURE 6. TYPICAL BASE-TO-EMITTER VOLTAGE CHARACTERISTIC vs TEMPERATURE FOR EACH TRANSISTOR

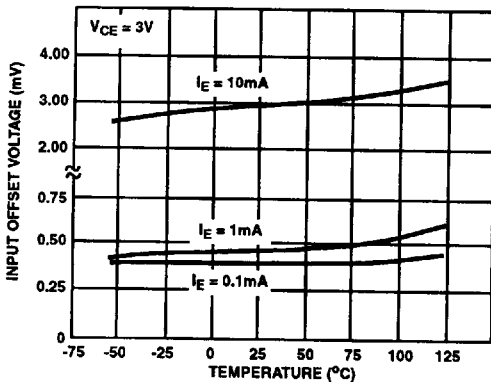


FIGURE 7. TYPICAL INPUT OFFSET VOLTAGE CHARACTERISTICS FOR DIFFERENTIAL PAIR AND PAIRED ISOLATED TRANSISTORS vs TEMPERATURE

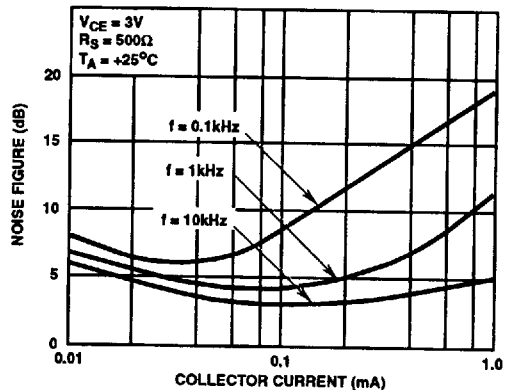


FIGURE 8. TYPICAL NOISE FIGURE vs COLLECTOR CURRENT

Typical Performance Curves (Continued)

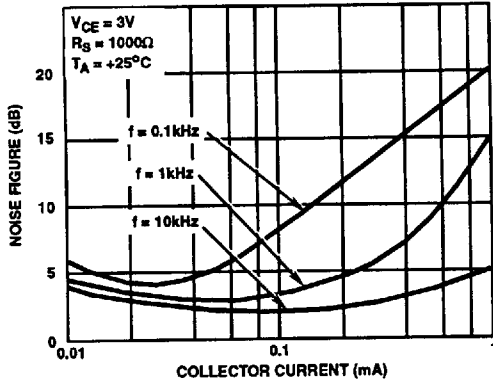


FIGURE 9. TYPICAL NOISE FIGURE vs COLLECTOR CURRENT

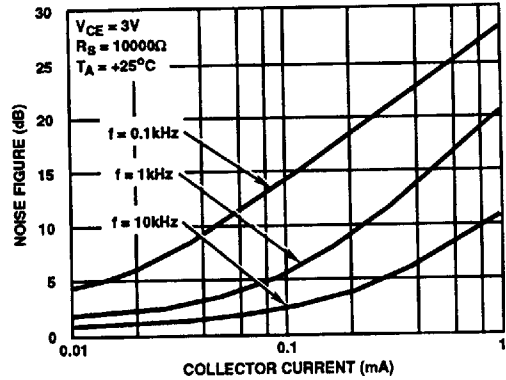


FIGURE 10. TYPICAL NOISE FIGURE vs COLLECTOR CURRENT

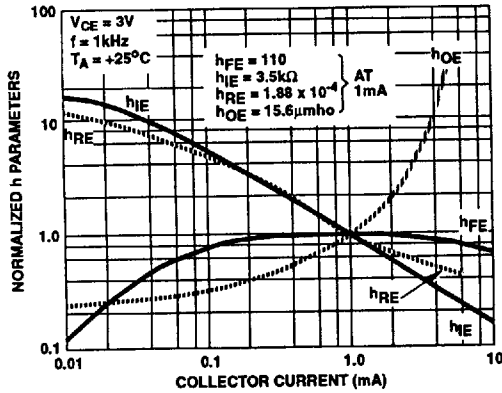


FIGURE 11. TYPICAL NORMALIZED FORWARD CURRENT TRANSFER RATIO, SHORT CIRCUIT INPUT IMPEDANCE, OPEN CIRCUIT OUTPUT IMPEDANCE, AND OPEN CIRCUIT REVERSE VOLTAGE TRANSFER RATIO vs COLLECTOR CURRENT

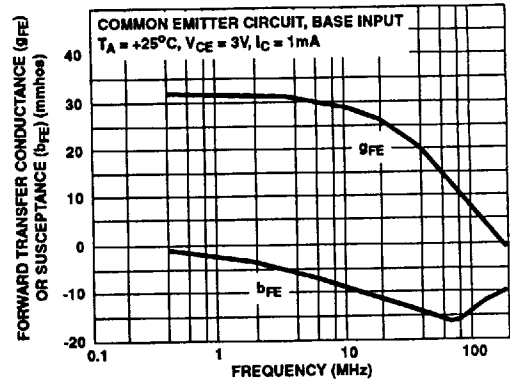


FIGURE 12. TYPICAL FORWARD TRANSFER ADMITTANCE vs FREQUENCY

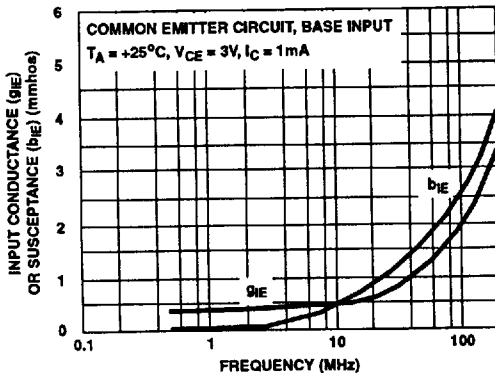


FIGURE 13. TYPICAL INPUT ADMITTANCE vs FREQUENCY

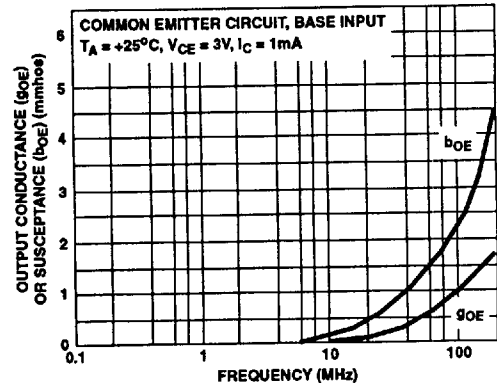


FIGURE 14. TYPICAL OUTPUT ADMITTANCE vs FREQUENCY

6  
TRANSISTOR AND  
DIODE ARRAYS

Typical Performance Curves (Continued)

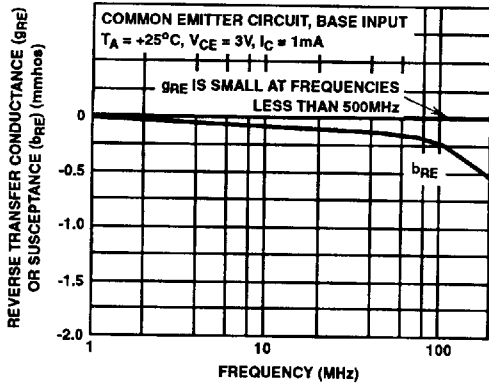


FIGURE 15. TYPICAL REVERSE TRANSFER ADMITTANCE vs FREQUENCY

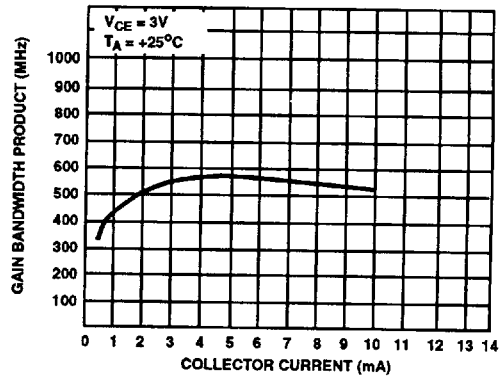


FIGURE 16. TYPICAL GAIN BANDWIDTH PRODUCT vs COLLECTOR CURRENT